

ULTRA LOW CAPACITANCE TVS ARRAY



DESCRIPTION

The DL0521P is an ultra low capacitance transient voltage suppressor array, designed to protect computing applications from the damaging effects of Electrostatic Discharge and Electrical Fast Transients.

The DL0521P meets IEC 61000-4-2 (ESD) and IEC 61000-4-4 (EFT) requirements. At higher operating frequencies or faster edge rates, insertion loss and signal integrity are a major concern. This device offers an ultra low capacitance and low leakage current in a miniature DFN-2-0402 package.

FEATURES

- Compatible with IEC 61000-4-2 (ESD)
- Compatible with IEC 61000-4-4 (EFT)
- Compatible with IEC 61000-4-5 (Surge)
- 20 Watts Peak Pulse Power per Line ($t_p = 8/20\mu s$)
- ESD Protection
- Low Clamping Voltage
- Protects One Bidirectional Line
- Ultra Low Capacitance: 0.6 pF
- RoHS Compliant
- REACH Compliant

APPLICATIONS

- Ethernet 10/100/1000 Base T
- FireWire
- Wireless Communications
- USB 1.0, USB 2.0 & USB 3.0

MECHANICAL CHARACTERISTICS

- Molded JEDEC DFN-2-0402 Package
- Approximate Weight: 2 milligrams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:
Pure-Tin - Sn, 100: 260-270°C
- 8mm Tape and Reel Per EIA Standard 481
- Flammability Rating UL 94V-0

PIN CONFIGURATION



TYPICAL DEVICE CHARACTERISTICS
MAXIMUM RATINGS @ 25°C Unless Otherwise Specified

PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power (tp = 8/20μs) - See Figure 1	P_{PP}	20	Watts
Operating Temperature	T_A	-55 to 150	°C
Storage Temperature	T_{STG}	-55 to 150	°C

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified

PART NUMBER	DEVICE MARKING	RATED STAND-OFF VOLTAGE V_{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA $V_{(BR)}$ VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ $I_p = 1A$ V_C VOLTS	MAXIMUM LEAKAGE CURRENT @ V_{WM} I_D μA	TYPICAL CAPACITANCE @ 0V, 1MHz C_J pF
DL0521P	S	5.0	6.0	20.0	1	0.6

TYPICAL DEVICE CHARACTERISTICS

FIGURE 1
PEAK PULSE POWER VS PULSE TIME

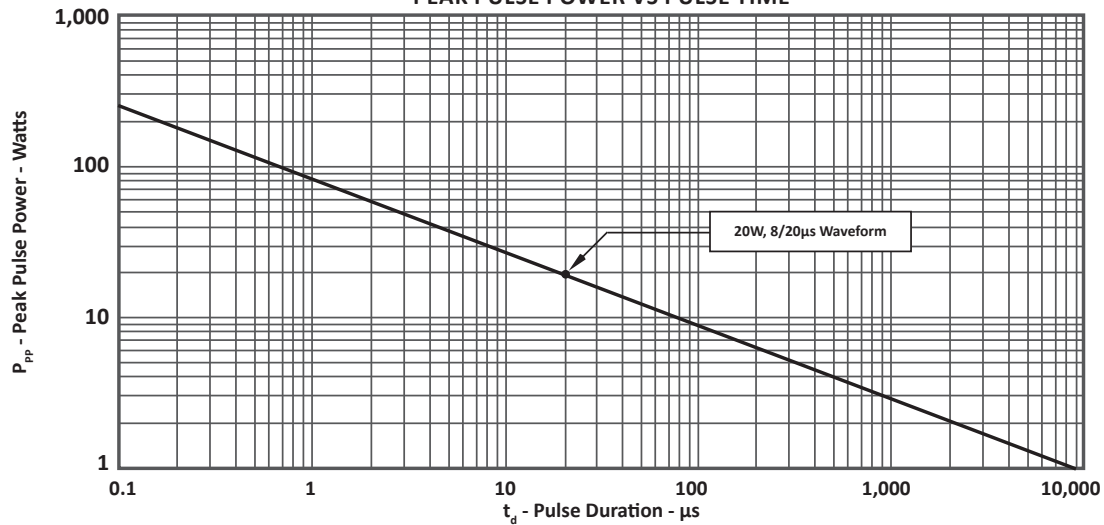
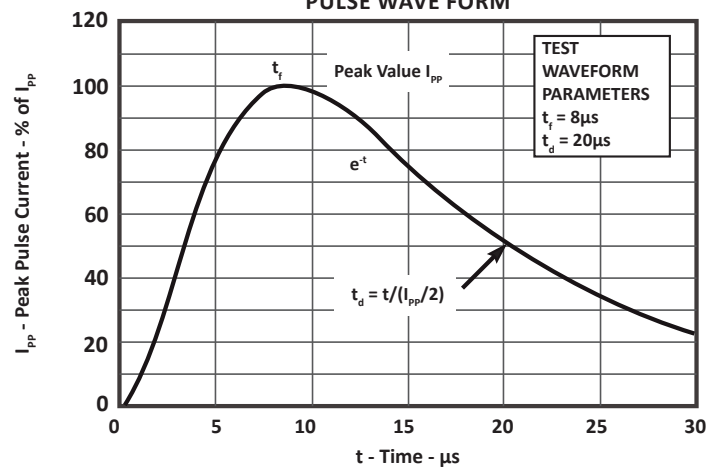


FIGURE 2
PULSE WAVE FORM



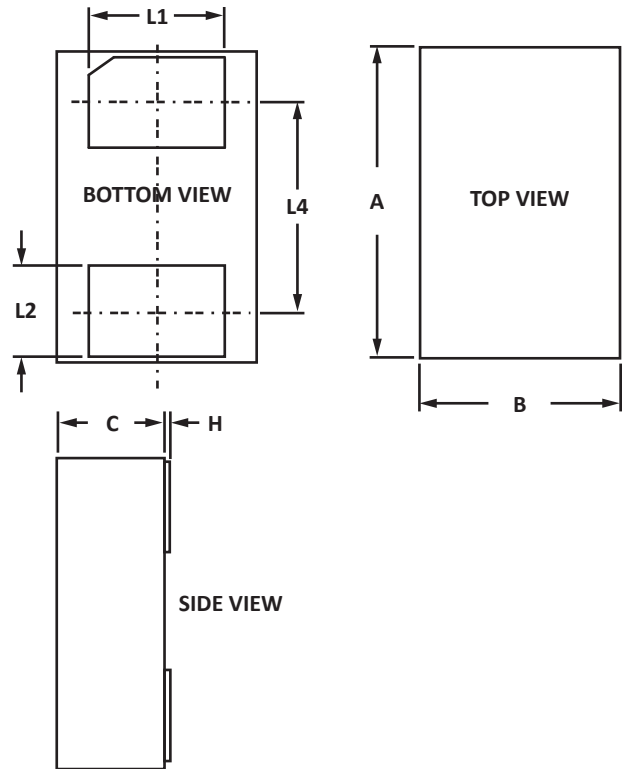
DFN-2-0402 PACKAGE INFORMATION

OUTLINE DIMENSIONS

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.90	1.05	0.035	0.041
B	0.51	0.65	0.02	0.024
C	0.51	0.60	0.02	0.024
H	0~0.10	0~0.10	0~0.004	0~0.004
L1	0.45	0.55	0.018	0.022
L2	0.18	0.30	0.007	0.012
L4	0.65 BSC		0.026 BSC	

NOTES

1. Dimensioning and tolerances per ANSI Y14.M, 1985.
2. Controlling dimension: inches.
3. Dimensions are exclusive of mold flash and metal burrs.

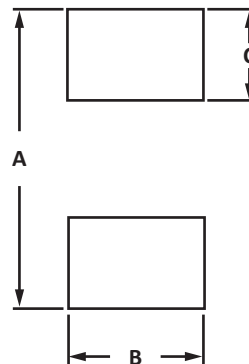


PAD LAYOUT DIMENSIONS

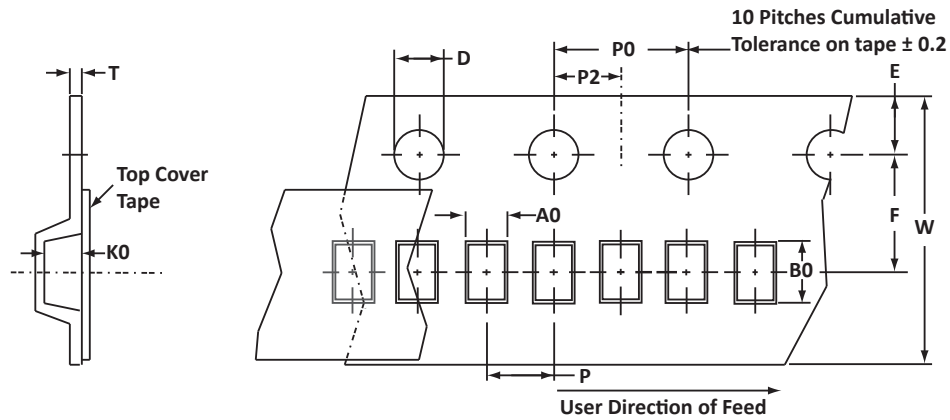
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.30	1.50	0.051	0.059
B	0.60	0.70	0.024	0.028
C	0.40	0.55	0.016	0.022

NOTES

1. Controlling dimension: inches.



TAPE AND REEL



SPECIFICATIONS

REEL DIA.	TAPE WIDTH	A0	B0	K0	D	E	F	W	P0	P2	P	tmax
178mm (7")	8mm	0.70 ± 0.05	1.15 ± 0.10	0.56 ± 0.05	1.55 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	2.00 ± 0.05	0.25

NOTES

- Dimensions are in millimeters.
- Surface mount product is taped and reeled in accordance with EIA-481.
- Suffix - T710 = 7" Reel - 10,000 pieces per 8mm tape.
- Marking on Part - marking code (see page 2).

Package outline, pad layout and tape specifications per document number 06094.R1 3/11 - Option 2.

ORDERING INFORMATION

BASE PART NUMBER	LEADFREE SUFFIX	TAPE SUFFIX	QTY/REEL	REEL SIZE	TUBE QTY
DL0521P	n/a	-T710	10,000	7"	n/a

This device is only available in a Lead-Free configuration.

COMPANY INFORMATION

COMPANY PROFILE

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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